# LMV7219

<span style="color:red">25-05970</span>

*LMV7219 7 nsec, 2.7V to 5V Comparator with Rail-to-Rail Output*

![Texas Instruments logo]

# *National Semiconductor*

## LMV7219
## 7 nsec, 2.7V to 5V Comparator with Rail-to-Rail Output

### General Description

The LMV7219 is a low-power, high-speed comparator with internal hysteresis. The LMV7219 operating voltage ranges from 2.7V to 5V with push/pull rail-to-rail output. This device achieves a 7ns propagation delay while consuming only 1.1mA of supply current at 5V.

The LMV7219 inputs have a common mode voltage range that extends 200mV below ground, allowing ground sensing. The internal hysteresis ensures clean output transitions even with slow-moving inputs signals.

The LMV7219 is available in the SC70-5 and SOT23-5 packages, which are ideal for systems where small size and low power are critical.
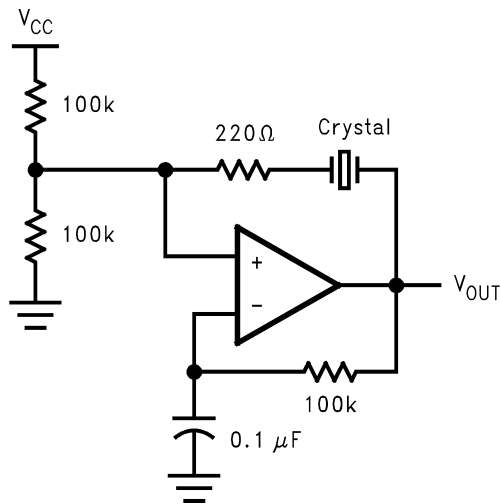
### Features

($V_S$ = 5V, $T_A$ = 25˚C, Typical values unless specified)
- Propagation delay                                     7ns
- Low supply current                                   1.1mA
- Input common mode voltage range extends 200mv below ground
- Ideal for 2.7V and 5V single supply applications
- Internal hysteresis ensures clean switching
- Fast rise and fall time                              1.3ns
- Available in space-saving packages:   5-pin SC70-5 and SOT23-5
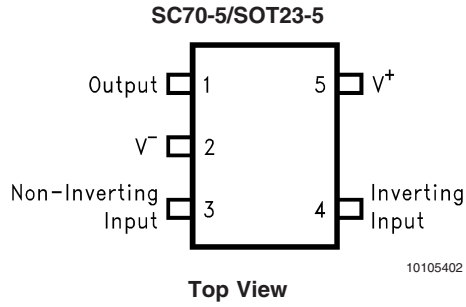
### Applications

- Portable and battery-powered systems
- Scanners
- Set top boxes
- High speed differential line receiver
- Window comparators
- Zero-crossing detectors
- High-speed sampling circuits

### Typical Application



10105401

# Connection Diagram

**SC70-5/SOT23-5**

Output 1    5 V+

V− 2

Non-Inverting Input 3    4 Inverting Input

10105402

**Top View**

# Ordering Information

| Package | Part Number | Marking | Supplied as | NSC Drawing |
|---|---|---|---|---|
| 5-pin SC70-5 | LMV7219M7 | C15 | 1k Units Tape and Reel | MAA05A |
|  | LMV7219M7X | C15 | 3k Units Tape and Reel |  |
| 5-pin SOT23-5 | LMV7219M5 | C14A | 1k Units Tape and Reel | MF05A |
|  | LMV7219M5X | C14A | 3k Units Tape and Reel |  |

# Simplified Schematic

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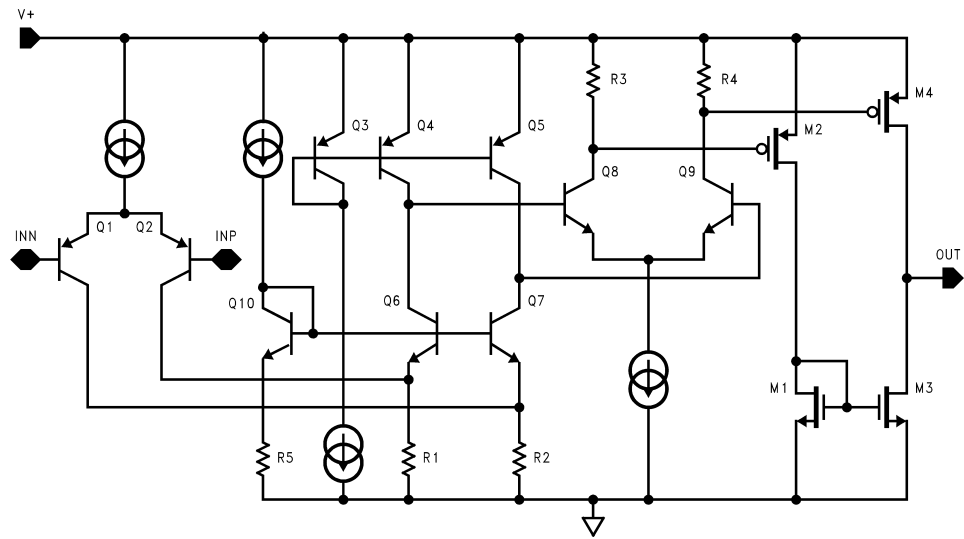
## Absolute Maximum Ratings (Note 1)

**If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.**

ESD Tolerance (Note 2)

    Machine Body             150V

    Human Model Body     2000V

Differential Input Voltage     ± Supply Voltage

Output Short Circuit Duration     (Note 3)

Supply Voltage ($V^+$ - $V^-$)     5.5V

Soldering Information

  Infrared or Convection (20 sec)     235˚C

  Wave Soldering (10 sec)     260˚C (lead temp)

Voltage at Input/Output pins     ($V^+$) + 0.4V

                                               ($V^-$) – 0.4V

Current at Input Pin (Note 9)     ±10mA

## Operating Ratings

Supply voltages ($V^+$ - $V^-$)     2.7V to 5V

Operating Temperature Range (Note 4)     −40˚C to +85˚C

Storage Temperature Range     −65˚C to +150˚C

Package Thermal Resistance

    SC70-5     478˚C/W

    SOT23-5     265˚C/W

## 2.7V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J$ = 25˚C, $V_{CM}$ = $V^+$/2, $V^+$ = 2.7V, $V^-$ = 0V, $C_L$ = 10 pF and $R_L$ > 1 MΩ to $V^-$. **Boldface** limits apply at the temperature extremes.

| Symbol | Parameter | Conditions | Typ (Note 5) | Limit (Note 6) | Units |
|---|---|---|---|---|---|
| $V_{OS}$ | Input Offset Voltage | | 1 | 6<br>**8** | mV<br>max |
| $I_B$ | Input Bias Current | | 450 | 950<br>**2000** | nA<br>max |
| $I_{OS}$ | Input Offset Current | | 50 | 200<br>**400** | nA<br>max |
| CMRR | Common Mode Rejection Ratio | 0V < $V_{CM}$ < 1.50V | 85 | 62<br>**55** | dB<br>min |
| PSRR | Power Supply Rejection Ratio | $V^+$ = 2.7V to 5V | 85 | 65<br>**55** | dB<br>min |
| $V_{CM}$ | Input Common-Voltage Range | CMRR > 50 dB | $V_{CC}$ −1 | $V_{CC}$ −1.2<br>**$V_{CC}$ −1.3** | V<br>min |
| | | | −0.2 | −0.1<br>**0** | V<br>max |
| $V_O$ | Output Swing High | $I_L$ = 4 mA,<br>$V_{ID}$ = 500 mV | $V_{CC}$ −0.22 | $V_{CC}$ −0.3<br>**$V_{CC}$ −0.4** | V<br>min |
| | | $I_L$ = 0.4 mA,<br>$V_{ID}$ = 500 mV | $V_{CC}$ −0.02 | $V_{CC}$ −0.05<br>**$V_{CC}$ −0.15** | |
| | Output Swing Low | $I_L$ = −4 mA,<br>$V_{ID}$ = −500 mV | 130 | 200<br>**300** | mV<br>max |
| | | $I_L$ = −0.4 mA,<br>$V_{ID}$ = −500 mV | 15 | 50<br>**150** | |
| $I_{SC}$ | Output Short Circuit Current | Sourcing,<br>$V_O$ = 0V (Note 3) | 20 | | mA |
| | | Sinking,<br>$V_O$ = 2.7V (Note 3) | 20 | | |
| $I_S$ | Supply Current | No Load | 0.9 | 1.6<br>**2.2** | mA<br>max |
| $V_{HYST}$ | Input Hysteresis Voltage | (Note 10) | 7 | | mV |
| $V_{TRIP^+}$ | Input Referred Positive Trip Point | (see *Figure 1*) | 3 | 8 | mV<br>max |
| $V_{TRIP^-}$ | Input Referred Negative Trip Point | (see *Figure 1*) | −4 | −8 | mV<br>min |

## 2.7V Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for $T_J$ = 25˚C, $V_{CM}$ = $V^+$/2, $V^+$ = 2.7V, $V^-$ = 0V, $C_L$ = 10 pF and $R_L$ > 1 MΩ to $V^-$. **Boldface** limits apply at the temperature extremes.

| Symbol | Parameter | Conditions | Typ (Note 5) | Limit (Note 6) | Units |
|---|---|---|---|---|---|
| $t_{PD}$ | Propagation Delay | Overdrive = 5 mV $V_{CM}$ = 0V (Note 7) | 12 | | ns max |
| | | Overdrive = 15 mV $V_{CM}$ = 0V (Note 7) | 11 | | |
| | | Overdrive = 50 mV $V_{CM}$ = 0V (Note 7) | 10 | 20 | |
| $t_{SKEW}$ | Propagation Delay Skew | (Note 8) | 1 | | ns |
| $t_r$ | Output Rise Time | 10% to 90% | 2.5 | | ns |
| $t_f$ | Output Fall Time | 90% to 10% | 2 | | ns |

## 5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J$ = 25˚C, $V_{CM}$ = $V^+$/2, $V^+$ = 5V, $V^-$ = 0V, $C_L$ = 10 pF and $R_L$ > 1 MΩ to $V^-$. **Boldface** limits apply at the temperature extremes.

| Symbol | Parameter | Conditions | Typ (Note 5) | Limit (Note 6) | Units |
|---|---|---|---|---|---|
| $V_{OS}$ | Input Offset Voltage | | 1 | 6 **8** | mV max |
| $I_B$ | Input Bias Current | | 500 | 950 **2000** | nA max |
| $I_{OS}$ | Input Offset Current | | 50 | 200 **400** | nA max |
| CMRR | Common Mode Rejection Ratio | 0V < $V_{CM}$ < 3.8V | 85 | 65 **55** | dB min |
| PSRR | Power Supply Rejection Ratio | $V^+$ = 2.7V to 5V | 85 | 65 **55** | dB min |
| $V_{CM}$ | Input Common-Mode Voltage Range | CMRR > 50 dB | $V_{CC}$ −1 | $V_{CC}$ −1.2 $V_{CC}$ −1.3 | V min |
| | | | −0.2 | −0.1 0 | V max |
| $V_O$ | Output Swing High | $I_L$ = 4 mA, $V_{ID}$ = 500 mV | $V_{CC}$ −0.13 | $V_{CC}$ −0.2 $V_{CC}$ −0.3 | V min |
| | | $I_L$ = 0.4 mA, $V_{ID}$ = 500 mV | $V_{CC}$ −0.02 | $V_{CC}$ −0.05 $V_{CC}$ −0.15 | |
| | Output Swing Low | $I_L$ = −4 mA, $V_{ID}$ = −500 mV | 80 | 180 **280** | mV max |
| | | $I_L$ = −0.4 mA, $V_{ID}$ = −500 mV | 10 | 50 **150** | |
| $I_{SC}$ | Output Short Circuit Current | Sourcing, $V_O$ = 0V (Note 3) | 68 | 30 **20** | mA min |
| | | Sinking, $V_O$ = 5V (Note 3) | 65 | 30 **20** | |
| $I_S$ | Supply Current | No Load | 1.1 | 1.8 **2.4** | mA max |
| $V_{HYST}$ | Input Hysteresis Voltage | (Note 10) | 7.5 | | mV |
| $V_{Trip^+}$ | Input Referred Positive Trip Point | (See figure 1) | 3.5 | 8 | mV max |
| $V_{Trip^-}$ | Input Referred Negative Trip Point | (See figure 1) | −4 | −8 | mV min |

## 5V Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for $T_J$ = 25°C, $V_{CM}$ = $V^+$/2, $V^+$ = 5V, $V^-$ = 0V, $C_L$ = 10 pF and $R_L$ > 1 MΩ to $V^-$. **Boldface** limits apply at the temperature extremes.

| Symbol | Parameter | Conditions | Typ (Note 5) | Limit (Note 6) | Units |
|---|---|---|---|---|---|
| $t_{PD}$ | Propagation Delay | Overdrive = 5 mV $V_{CM}$ = 0V (Note 7) | 9 | | ns max |
| | | Overdrive = 15mV $V_{CM}$ = 0V (Note 7) | 8 | 20 | |
| | | Overdrive = 50 mV $V_{CM}$ = 0V (Note 7) | 7 | 19 | |
| $t_{SKEW}$ | Propagation Delay Skew | (Note 8) | 0.4 | | ns |
| $t_r$ | Output Rise Time | 10% to 90% | 1.3 | | ns |
| $t_f$ | Output Fall Time | 90% to 10% | 1.25 | | ns |

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical characteristics.

**Note 2:** Human body model, 1.5 kΩ in series with 100 pF. Machine model, 200Ω in series with 100 pF.

**Note 3:** Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of ±30mA over long term may adversely affect reliability.

**Note 4:** The maximum power dissipation is a function of $T_{J(MAX)}$, $\theta_{JA}$, and $T_A$. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly into a PC board.

**Note 5:** Typical Values represent the most likely parametric norm.

**Note 6:** All limits are guaranteed by testing or statistical analysis.

**Note 7:** Propagation delay measurements made with 100 mV steps. Overdrive is measure relative to $V_{Trip}$.

**Note 8:** Propagation Delay Skew is defined as absolute value of the difference between $t_{PDLH}$ and $t_{PDHL}$.

**Note 9:** Limiting input pin current is only necessary for input voltages that exceed absolute maximum input voltage ratings.

**Note 10:** The LMV7219 comparator has internal hysteresis. The trip points are the input voltage needed to change the output state in each direction. The offset voltage is defined as the average of $V_{trip+}$ and $V_{trip-}$, while the hysteresis voltage is the difference of these two.
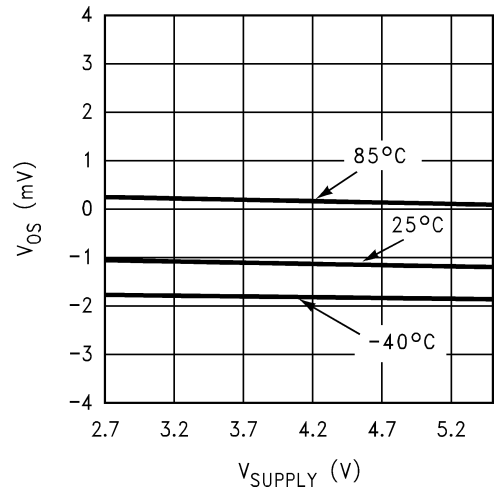
# Typical Performance Characteristics Unless otherwise specified, $V_S = 5V$, $C_L = 10$ pF, $T_A = 25°C$

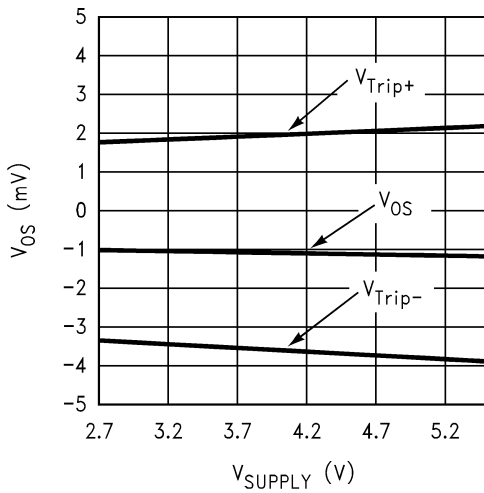**Supply Current vs. Supply Voltage**
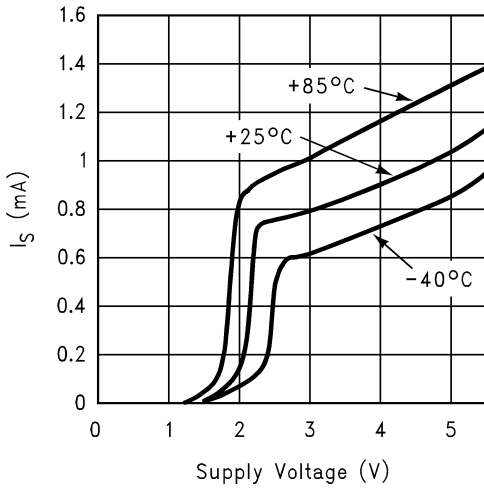


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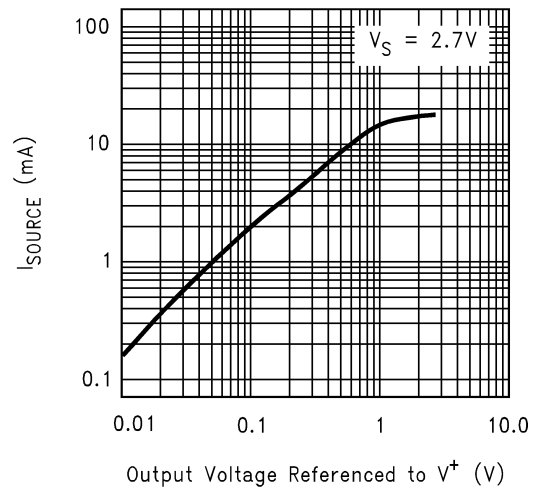
**$V_{OS}$ vs. Supply Voltage**



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**Input Offset and Trip Voltage vs. Supply Voltage**
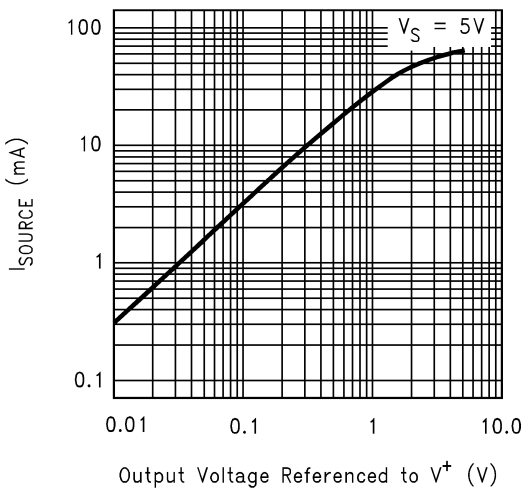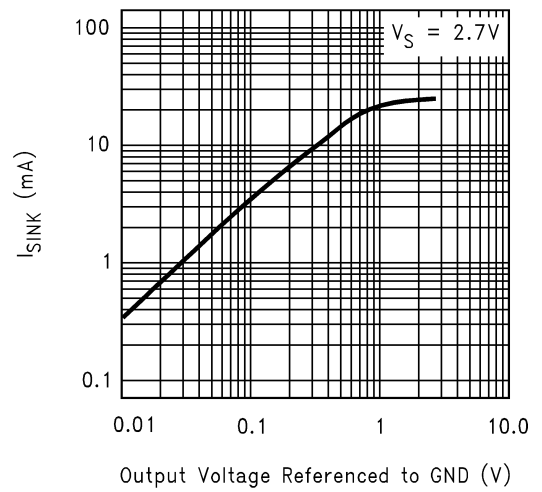


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**Sourcing Current vs. Output Voltage**



10105408

**Sourcing Current vs. Output Voltage**



10105409

**Sinking Current vs. Output Voltage**



10105410

# Typical Performance Characteristics Unless otherwise specified, $V_S$ = 5V, $C_L$ = 10 pF, $T_A$ = 25°C (Continued)

**Sinking Current vs. Output Voltage**



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**Propagation Delay vs. Temperature**
**($V_S$ = 2.7V, $V_{OD}$ = 15 mV)**



10105412

**Propagation Delay vs. Temperature**
**($V_S$ = 5V, $V_{OD}$ = 15 mV)**



10105413

**Propagation Delay vs. Capacitive Load**
**($V_S$ = 5V, $V_{OD}$ = 15 mV)**



10105414

**Propagation Delay vs. Input Overdrive**



10105415

**Propagation Delay ($t_{PD}$-)**



10105416

## Typical Performance Characteristics Unless otherwise specified, $V_S$ = 5V, $C_L$ = 10 pF, $T_A$ = 25°C (Continued)

**Propagation Delay ($t_{PD+}$)**



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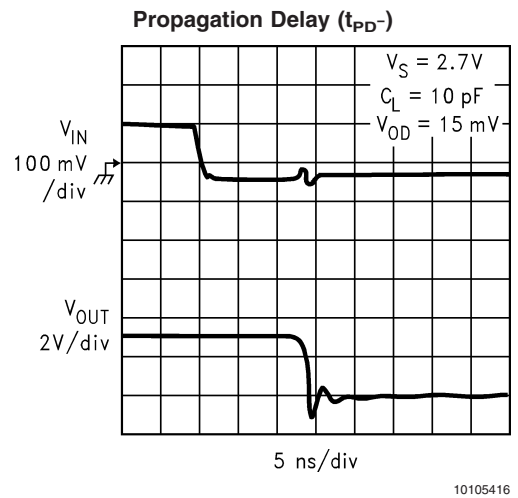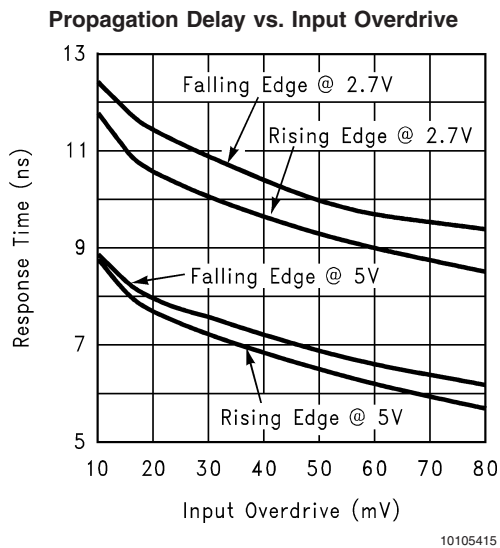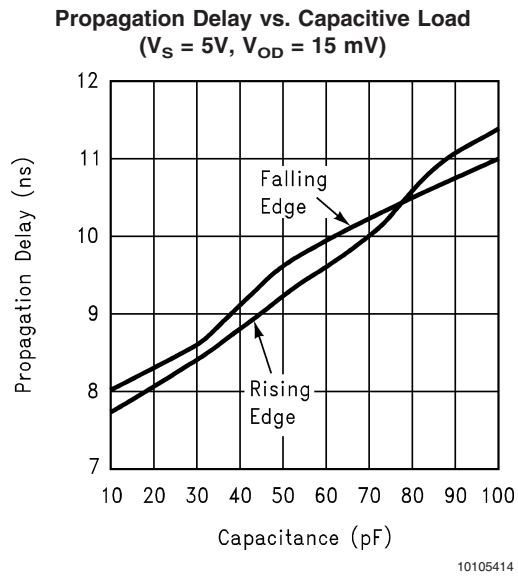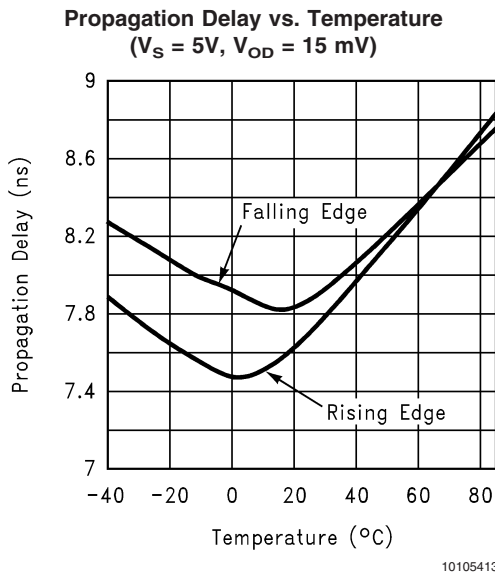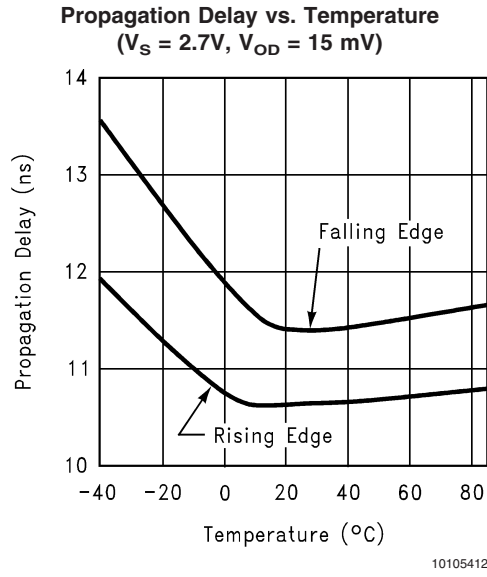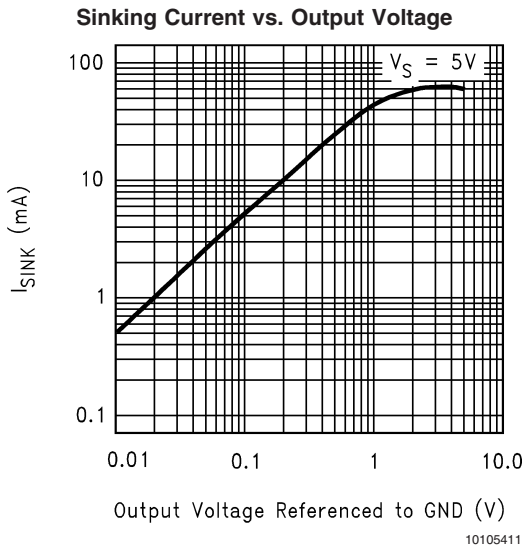
## Application Section

LMV7219 is a single supply comparator with internal hysteresis, 7ns of propagation delay and only 1.1mA of supply current.

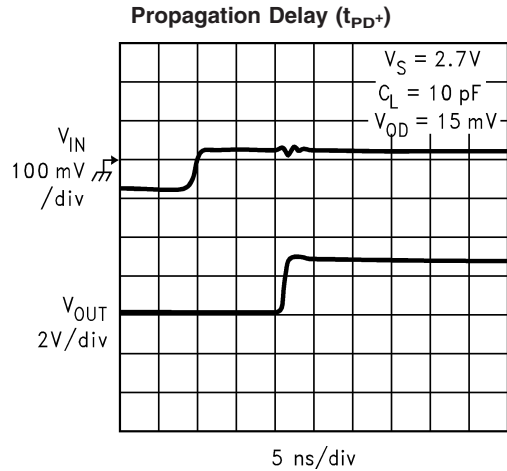The LMV7219 has a typical input common mode voltage range of −0.2V below the ground to 1V below $V_{cc}$. The differential input stage is a pair of PNP transistors, therefore, the input bias current flows out of the device. If either of the input signals falls below the negative common mode limit, the parasitic PN junction formed by the substrate and the base of the PNP will turn on, resulting in an increase of input bias current.

If one of the inputs goes above the positive common mode limit, the output will still maintain the correct logic level as long as the other input stays within the common mode range. However, the propagation delay will increase. When both inputs are outside the common mode voltage range, current saturation occurs in the input stage, and the output becomes unpredictable.

The propagation delay does not increase significantly with large differential input voltages. However, large differential voltages greater than the supply voltage should be avoided to prevent damages to the input stage.

The LMV7219 has a push pull output. When the output switches, there is a direct path between $V_{CC}$ and ground, causing high output sinking or sourcing current during the transition. After the transition, the output current decreases and the supply current settles back to about 1.1mA at 5V, thus conserving power consumption.

Most high-speed comparators oscillate when the voltage of one of the inputs is close to or equal to the voltage on the other input due to noise or undesirable feedback. The LMV7219 have 7mV of internal hysteresis to counter parasitic effects and noise. The hysteresis does not change significantly with the supply voltages and the common mode input voltages as reflected in the specification table.

The internal hysteresis creates two trip points, one for the rising input voltage and one for the falling input voltage. The difference between the trip points is the hysteresis. With internal hysteresis, when the comparator's input voltages are equal, the hysteresis effectively causes one comparator-input voltage to move quickly past the other, thus taking the input out of the region where oscillation occurs. Standard comparators require hysteresis to be added with external resistors. The fixed internal hysteresis eliminates these resistors.
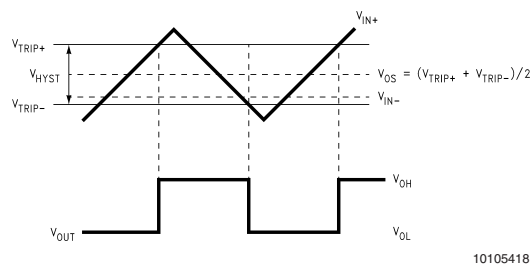


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**FIGURE 1. Input and Output Waveforms, Non-Inverting Input Varied**

# Additional Hysteresis

If additional hysteresis is desired, this can be done with the addition of three resistors using positive feedback, as shown in *Figure 2*. The positive feedback method slows the comparator response time. Calculate the resistor values as follows:

1) Select R3. The current through R3 should be greater than the input bias current to minimize errors. The current through R3 ($I_F$) at the trip point is ($V_{REF}$ - $V_{OUT}$) /R3. Consider the two possible output states when solving for R3, and use the smaller of the two resulting resistor values. The two formulas are:

$R3 = V_{REF}/I_F$         (when $V_{OUT} = 0$)

$R3 = V_{CC}$ - $V_{REF}$ /$I_F$      ($V_{OUT} = V_{CC}$)

2) Choose a hysteresis band required ($V_{HB}$).

3) Calculate R1, where $R1 = R3$ X($V_{HB}/V_{CC}$)

4) Choose the trip point for $V_{IN}$ rising. This is the threshold voltage ($V_{THR}$) at which the comparator switches from low to high as $V_{IN}$ rises about the trip point.

5) Calculate R2 as follows:

$$R_2 = \frac{1}{\left(\dfrac{V_{THR}}{V_{REF} \times R_1}\right) - \dfrac{1}{R_1} - \dfrac{1}{R_3}}$$
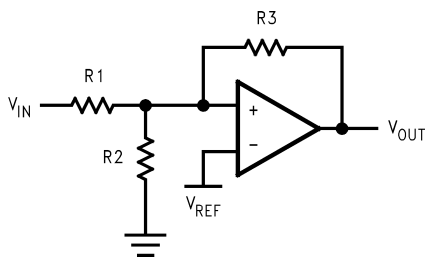
6) Verify the trip voltage and hysteresis as follows:

$$V_{IN} \text{ rising:} \quad V_{THR} = V_{REF} \times R_1 \times \left(\frac{1}{R_1} + \frac{1}{R_2} + \frac{1}{R_3}\right)$$

$$V_{IN} \text{ falling:} \quad V_{THF} = V_{THR} - \left(\frac{R_1 \times V_{CC}}{R_3}\right)$$

$$\text{Hysteresis} = V_{THR} - V_{THF}$$

This method is recommended for additional hysteresis of up to a few hundred millivolts. Beyond that, the impedance of R3 is low enough to affect the bias string and adjustment of R1 may be also required.



**FIGURE 2. Additional Hysteresis**

# Circuit Layout and Bypassing

The LMV7219 requires high-speed layout. Follow these layout guidelines:

1. Power supply bypassing is critical, and will improve stability and transient response. A decoupling capacitor such as 0.1µF ceramic should be placed as close as possible to V⁺ pin. An additional 2.2µF tantalum capacitor may be required for extra noise reduction.

2. Keep all leads short to reduce stray capacitance and lead inductance. It will also minimize unwanted parasitic feedback around the comparator.

3. The device should be soldered directly to the PC board instead of using a socket.

4. Use a PC board with a good, unbroken low inductance ground plane. Make sure ground paths are low-impedance, especially were heavier currents are flowing.

5. Input traces should be kept away from output traces. This can be achieved by running a topside ground plane between the output and inputs.

6. Run the ground trace under the device up to the bypass capacitor to shield the inputs from the outputs.

7. To prevent parasitic feedback when input signals are slow-moving, a small capacitor of 1000pF or less can be placed between the inputs. It can also help eliminate oscillations in the transition region. However, this capacitor can cause some degradation to tpd when the source impedance is low.

# Zero-Crossing Detector

The inverting input is connected to ground and the non-inverting input is connected to 100mVp-p signal. As the signal at the non-inverting input crosses 0V, the comparator's output Changes State.
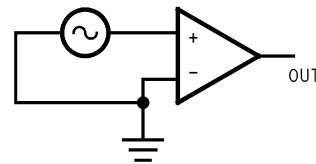


**FIGURE 3. Zero-Crossing Detector**

# Threshold Detector

Instead of tying the inverting input to 0V, the inverting input can be tied to a reference voltage. The non-inverting input is connected to the input. As the input passes the $V_{REF}$ threshold, the comparator's output changes state.
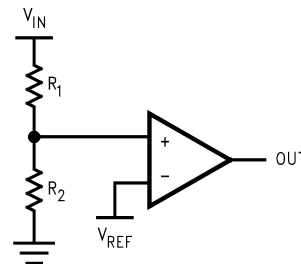


**FIGURE 4. Threshold Detector**

# Crystal Oscillator

A simple crystal oscillator using the LMV7219 is shown below. Resistors R1 and R2 set the bias point at the comparator's non-inverting input. Resistors R3, R4 and C1 sets the inverting input node at an appropriate DC average level based on the output. The crystal's path provides resonant positive feedback and stable oscillation occurs. The output duty cycle for this circuit is roughly 50%, but it is affected by resistor tolerances and to a lesser extent by the comparator offset.
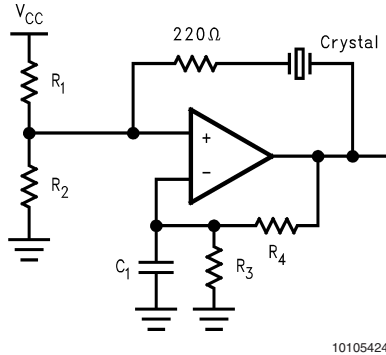


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**FIGURE 5. Crystal Oscillator**

# IR Receiver

The LMV7219 is an ideal candidate to be used as an infrared receiver. The infrared photo diode creates a current relative to the amount of infrared light present. The current creates a voltage across RD. When this voltage level cross the voltage applied by the voltage divider to the inverting input, the output transitions.



10105425

**FIGURE 6. IR Receiver**

# Physical Dimensions   inches (millimeters) unless otherwise noted

2±0.1    A

SYMM ℄

0.65

3    2    1

B

1.8-2.4

1.25±0.1

4    5

5X 0.15-0.30

1.3

⊕ 0.1Ⓜ C BⓈ AⓈ

SYMM ℄

(0.65)

(1.9)

(5X 0.75)

(5X 0.4)

(1.3)

**LAND PATTERN RECOMMENDATION**

0.8-1.1    (0.9)

☐ 0.1 C    C

SEATING PLANE

0-0.1

**DIMENSIONS ARE IN MILLIMETERS**

R0.025 MIN TYP

R0.025 MIN TYP    GAGE PLANE

0°-5° TYP    0.2

0.1-0.2

0.4±0.05 TYP

(0.515 TYP)

MAA05A (Rev C)

**5-Pin SC70-5**
**NS Package Number MAA05A**

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



0.112–0.118
[2.84–3.00]

0.106–0.118
[2.69–3.00]

0.060–0.066
[1.52–1.68]

0.0375
[0.95]

0.075
[1.90]

0.0145–0.0195
[0.37–0.50]

SYMM
C̵L

0.0375
[0.95]

0.0375
[0.95]

0.102
[2.59]

0.039 TYP
[0.99]

0.027 TYP
[0.69]

LAND PATTERN RECOMMENDATION

0.038–0.048
[0.97–1.22]

–C–

0.036–0.044
[0.91–1.12]

0°–10° TYP

0.002–0.006
[0.05–0.15]
TYP

⌳ 0.004 [0.1] C

0.0050–0.0075
[0.13–0.19] TYP

GAGE
PLANE

0.008
[0.20]

(0.025)
[0.64]

0.140–0.0215
[0.36–0.55]
TYP

SEATING
PLANE

MA05B (REV B)

**5-Pin SOT23-5**
**NS Package Number MF05A**

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